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November 6, 2002

Subject:

Information Disclosure Statement

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TECHNOLOGY CENTER R3700

Application:

Group Art Unit:

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U.S.S.N.:

10/077,960

Filing Date:

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Enclosures:

Information Disclosure Statement Patent Documents

Information Disclosure Statement Non-Patent Literature

Copies of References

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U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. TRADEME! 10/077,960 Application Number TRANSMITTAL February 19, 2002 **Filing Date FORM** Patrick R. Connelly **First Named Inventor** Group Art Unit 3762 (to be used for all correspondence after initial filing) **Examiner Name** BTI-2 Attorney Docket Number Total Number of Pages in This Submission TECHNOLOGY 100 Pa700 **ENCLOSURES** (check all that apply) After Allowance Communication Assignment Papers Fee Transmittal Form to Group (for an Application) Appeal Communication to Board Fee Attached Drawing(s) of Appeals and Interferences Appeal Communication to Group Licensing-related Papers Amendment/Reply (Appeal Notice, Brief, Reply Brief) Petition After Final Proprietary Information Petition to Convert to a **Provisional Application** Affidavits/declaration(s) Status Letter Power of Attorney, Revocation Change of Correspondence Other Enclosure(s) (please X Extension of Time Request Address identify below): Transmittal Form Terminal Disclaimer Transmittal of Information Disclosure Statement **Express Abandonment Request** Request for Refund Certificate of ba Copy of Cited References Information Disclosure Statement CD, Number of CD(s) Return Postcard Certified Copy of Priority Document(s) Remarks Response to Missing Parts/ Incomplete Application Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT Firm Greenwald & Basch LLP Individual name By: Duane C. Basch Signature Date CERTIFICATE OF MAILING I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, DC 20231 on this date: Typed or printed name Duane C. Basch Date Signature

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PATENT titioner's Docket No.: **BTI-2** IN THE UNITED STATES PATENT AND TRADEMARK OFFICE re application of: RECEIVED Group No.: 3762 10/077,960 Application No.: 3147 Confirmation No: February 19, 2002

An Electromagnetic Interference Immune Tissue Invasive System

TECHNOLOGY CENTER R3700 Filed: For: Assistant Commissioner for Patents Washington, D.C. 20231 TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT WITHIN THREE MONTHS OF FILING OR BEFORE MAILING OF FIRST OFFICE ACTION (37 C.F.R. section 1.97(b)) IDENTIFICATION OF TIME OF FILING THE ACCOMPANYING INFORMATION DISCLOSURE STATEMENT 1) The information disclosure statement submitted herewith is being filed within three months of the filing date of the application or date of entry into the national stage of an international application or before the mailing date of a first Office action on the merits, whichever event occurs last. 37 C.F.R. section 1.97(b). or 2) The Information Disclosure Statement submitted herewith contains information that was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement. 37 C.F.R. section 1.97 (e) (1) Duane C. Basch Registration No. 34.545 Greenwald & Basch LLP **Suite 2490** 349 West Commercial Street East Rochester, NY 14445 US 585-387-0280 Customer No. 27157 CERTIFICATE OF MAILING/TRANSMISSION (37 C.F.R. section 1.8(a)) I hereby certify that, on the date shown below, this correspondence is being: MAILING **FACSIMILE** transmitted by facsimile to the Patent and deposited with the United States Postal Service with Trademark Office. sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for

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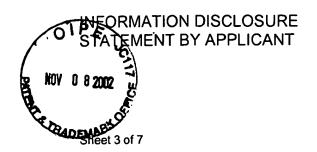
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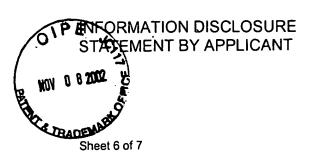
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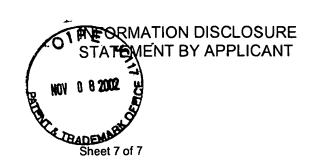
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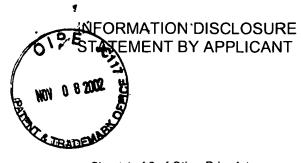
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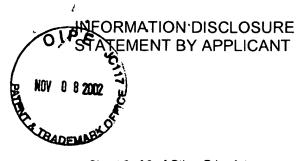
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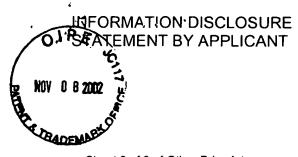
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